

4M-BIT CMOS FAST SRAM

256K-WORD BY 16-BIT

Description

The μ PD434016A is a high speed, low power, 4,194,304 bits (262,144 words by 16 bits) CMOS static RAM.

Operating supply voltage is 5.0 V $\pm$ 0.5 V.

The μ PD434016A is packaged in 44-pin plastic SOJ and 44-pin plastic TSOP (II).

Features

- 262,144 words by 16 bits organization
- Fast access time : 12, 15, 17, 20 ns (MAX.)
- Byte data control : /LB (I/O1 - I/O8), /UB (I/O9 - I/O16)
- Output Enable input for easy application
- Single +5.0 V power supply

Ordering Information

Part number	Package	Access time (MAX.)	Supply current (MAX.)	
			At operating	At standby
μ PD434016ALE-12	44-pin plastic SOJ (400 mil)	12 ns	230 mA	10 mA
μ PD434016ALE-15		15 ns	220 mA	
μ PD434016ALE-17		17 ns	210 mA	
μ PD434016ALE-20		20 ns	200 mA	
μ PD434016AG5-12-7JF	44-pin plastic TSOP (II) (400 mil) (Normal bent)	12 ns	230 mA	
μ PD434016AG5-15-7JF		15 ns	220 mA	
μ PD434016AG5-17-7JF		17 ns	210 mA	
μ PD434016AG5-20-7JF		20 ns	200 mA	

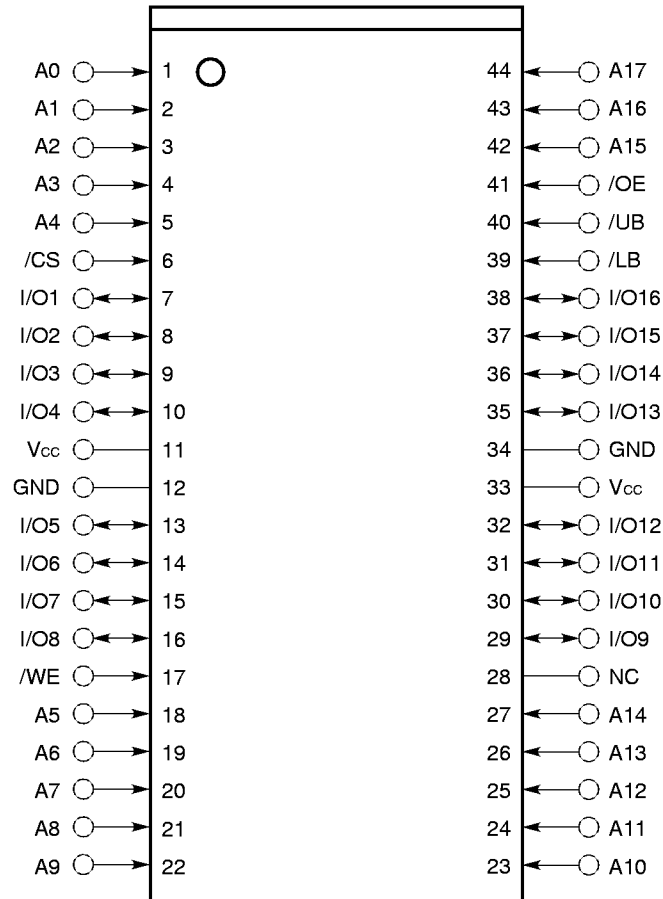
The information in this document is subject to change without notice.

Pin Configurations (Marking Side)

/xxx indicates active low signal.

44-pin plastic SOJ (400 mil)

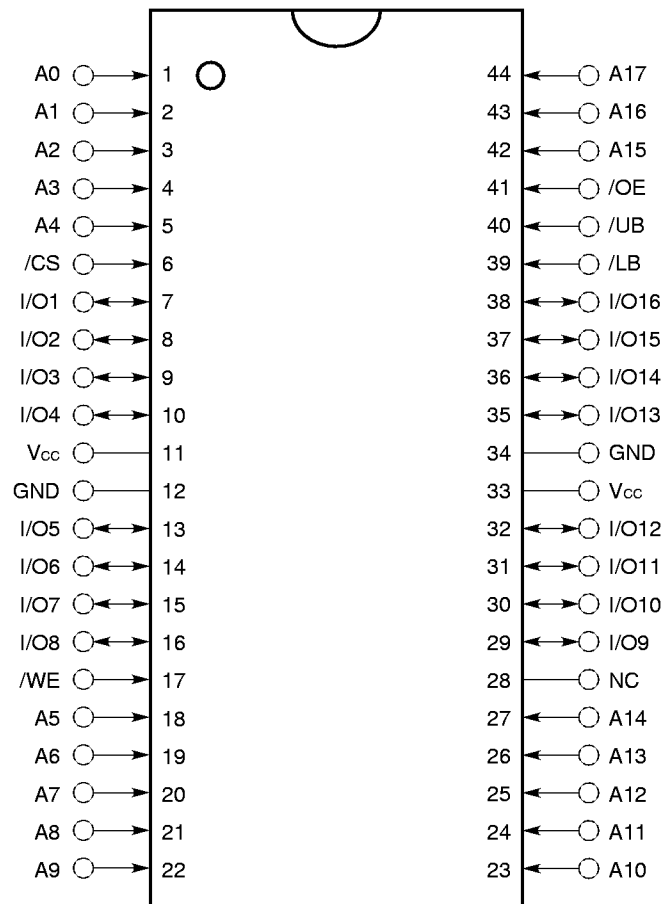
[μPD434016ALE]



- A0 - A17 : Address Inputs
- I/O1 - I/O16 : Data Inputs / Outputs
- /CS : Chip Select
- /WE : Write Enable
- /OE : Output Enable
- /LB, /UB : Byte data select
- Vcc : Power supply
- GND : Ground
- NC : No connection

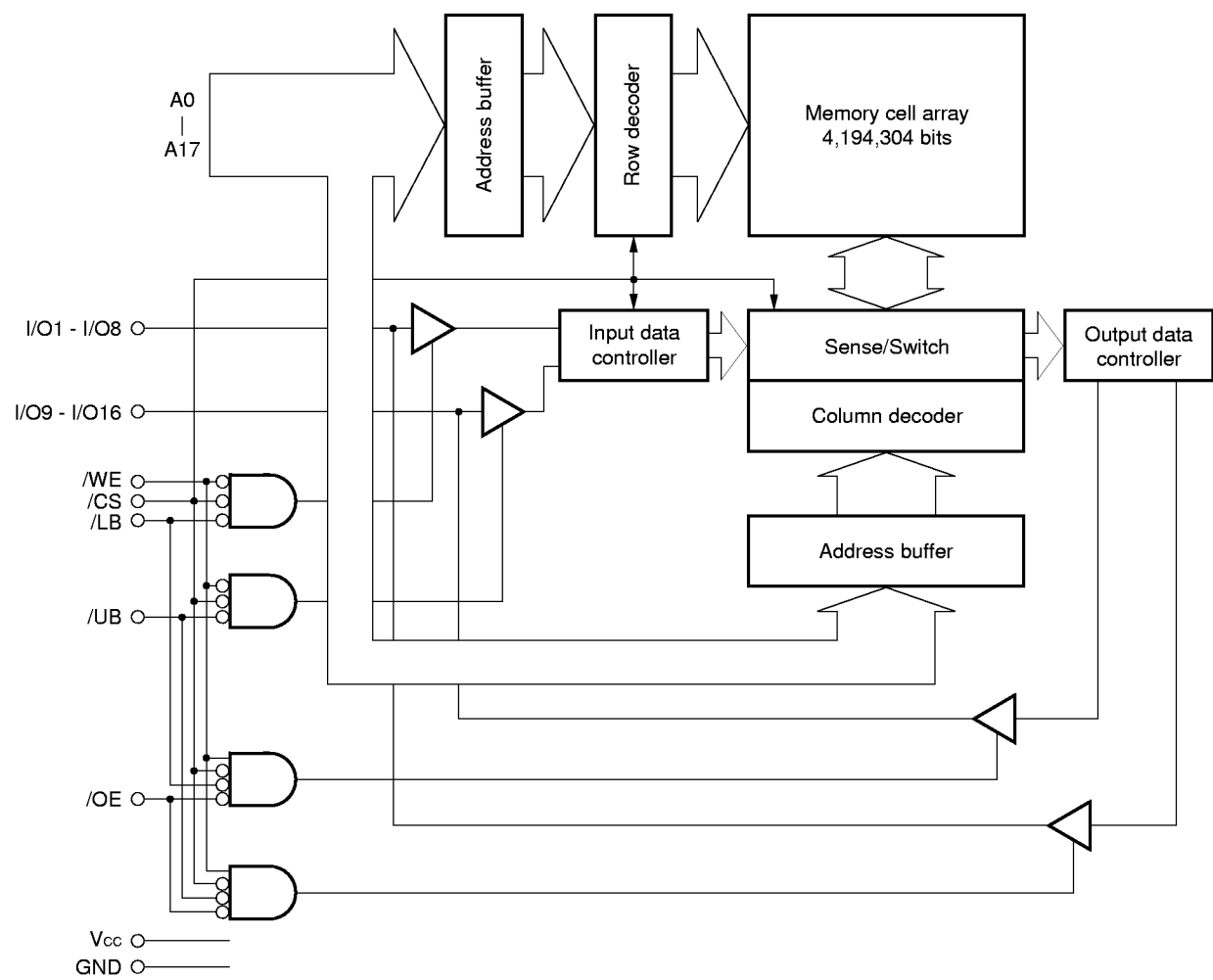
44-pin plastic TSOP (II) (400 mil) (Normal Bent)

[μPD434016AG5-7JF]



A0 - A17 : Address Inputs
 I/O1 - I/O16 : Data Inputs / Outputs
 /CS : Chip Select
 /WE : Write Enable
 /OE : Output Enable
 /LB, /UB : Byte data select
 V_{cc} : Power supply
 GND : Ground
 NC : No connection

Block Diagram



Truth Table

/CS	/OE	/WE	/LB	/UB	Mode	I/O		Supply current
						I/O1 - I/O8	I/O9 - I/O16	
H	x	x	x	x	Not selected	High impedance	High impedance	I _{SB}
L	L	H	L	L	Read	D _{OUT}	D _{OUT}	I _{CC}
			L	H		D _{OUT}	High impedance	
			H	L		High impedance	D _{OUT}	
L	x	L	L	L	Write	D _{IN}	D _{IN}	
			L	H		D _{IN}	High impedance	
			H	L		High impedance	D _{IN}	
L	H	H	x	x	Output disable	High impedance	High impedance	
L	x	x	H	H		High impedance	High impedance	

Remark x : Don't care

Electrical Specifications

Absolute Maximum Ratings

Parameter	Symbol	Condition	Rating	Unit
Supply voltage	V _{CC}		−0.5 ^{Note} to +7.0	V
Input / Output voltage	V _I		−0.5 ^{Note} to V _{CC} +0.5	V
Operating ambient temperature	T _A		0 to +70	°C
Storage temperature	T _{stg}		−55 to +125	°C

Note −2.0 V (MIN.) (pulse width : 2 ns)

Caution Exposing the device to stress above those listed in Absolute Maximum Rating could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational section of this specification. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Supply voltage	V _{CC}		4.5	5.0	5.5	V
High level input voltage	V _{IH}		2.2		V _{CC} +0.5	V
Low level input voltage	V _{IL}		−0.5 ^{Note}		+0.8	V
Operating ambient temperature	T _A		0		70	°C

Note −2.0 V (MIN.) (pulse width : 2 ns)

DC Characteristics (Recommended Operating Conditions Unless Otherwise Noted)

Parameter	Symbol	Test condition	MIN.	TYP.	MAX.	Unit
Input leakage current	I_{LI}	$V_{IN} = 0\text{ V to }V_{CC}$	-2		+2	μA
Output leakage current	I_{LO}	$V_{I/O} = 0\text{ V to }V_{CC}$, $/CS = V_{IH}$ or $/OE = V_{IH}$ or $/WE = V_{IL}$ or $/LB = V_{IH}$ or $/UB = V_{IH}$	-2		+2	μA
Operating supply current	I_{CC}	$/CS = V_{IL}$, $I_{I/O} = 0\text{ mA}$, Minimum cycle time	Cycle time : 12 ns		230	mA
			Cycle time : 15 ns		220	
			Cycle time : 17 ns		210	
			Cycle time : 20 ns		200	
Standby supply current	I_{SB}	$/CS = V_{IH}$, $V_{IN} = V_{IH}$ or V_{IL}			50	mA
	I_{SB1}	$V_{CC} - 0.2\text{ V} \leq /CS$, $V_{IN} \leq 0.2\text{ V}$ or $V_{CC} - 0.2\text{ V} \leq V_{IN}$			10	
High level output voltage	V_{OH}	$I_{OH} = -4.0\text{ mA}$	2.4			V
Low level output voltage	V_{OL}	$I_{OL} = +8.0\text{ mA}$			0.4	V

Remark V_{IN} : Input voltage

Capacitance ($T_A = 25\text{ }^{\circ}\text{C}$, $f = 1\text{ MHz}$)

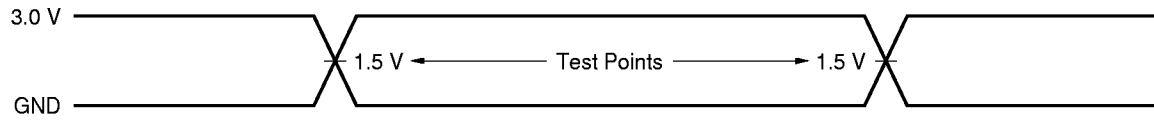
Parameter	Symbol	Test condition	MIN.	TYP.	MAX.	Unit
Input capacitance	C_{IN}	$V_{IN} = 0\text{ V}$			6	pF
Input / Output capacitance	$C_{I/O}$	$V_{I/O} = 0\text{ V}$			10	pF

- Remarks**
1. V_{IN} : Input voltage
 2. These parameters are periodically sampled and not 100% tested.

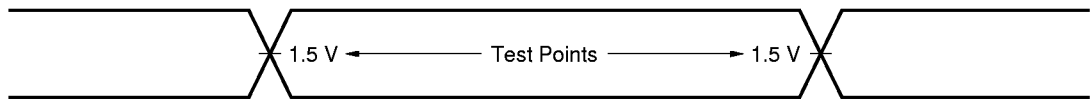
AC Characteristics (Recommended Operating Conditions Unless Otherwise Noted)

AC Test Conditions

Input Waveform (Rise and Fall Time ≤ 3 ns)



Output Waveform



Output Load

AC characteristics directed with the note should be measured with the output load shown in **Figure 1** or **Figure 2**.

Figure 1

(for t_{AA} , t_{ACS} , t_{OE} , t_{ABD} , t_{OH})

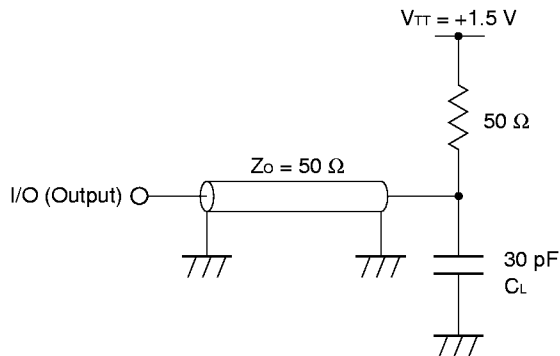
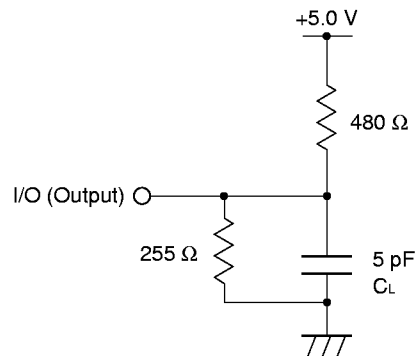


Figure 2

(for t_{CLZ} , t_{OLZ} , t_{BLZ} , t_{CHZ} , t_{OHZ} , t_{BHZ} , t_{WHZ} , t_{OW})



Remark C_L includes capacitances of the probe and jig, and stray capacitances.

Read Cycle

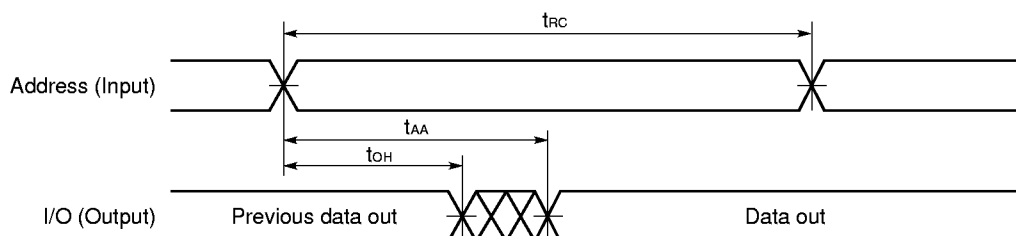
Parameter	Symbol	-12		-15		-17		-20		Unit	Notes
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
Read cycle time	t_{RC}	12		15		17		20		ns	
Address access time	t_{AA}		12		15		17		20	ns	1
/CS access time	t_{ACS}		12		15		17		20	ns	
/OE access time	t_{OE}		6		7		8		10	ns	
/LB, /UB access time	t_{ABD}		6		7		8		10	ns	
Output hold from address change	t_{OH}	3		3		3		3		ns	
/CS to output in low impedance	t_{CLZ}	3		3		3		3		ns	2, 3
/OE to output in low impedance	t_{OLZ}	0		0		0		0		ns	
/LB, /UB to output in low impedance	t_{BLZ}	0		0		0		0		ns	
/CS to output in high impedance	t_{CHZ}		6		7		8		8	ns	
/OE to output hold in high impedance	t_{OHZ}		6		7		8		8	ns	
/LB, /UB to output hold in high impedance	t_{BHZ}		6		7		8		8	ns	

Notes 1. See the output load shown in **Figure 1**.

2. Transition is measured at ± 200 mV from steady-state voltage with the output load shown in **Figure 2**.

3. These parameters are periodically sampled and not 100% tested.

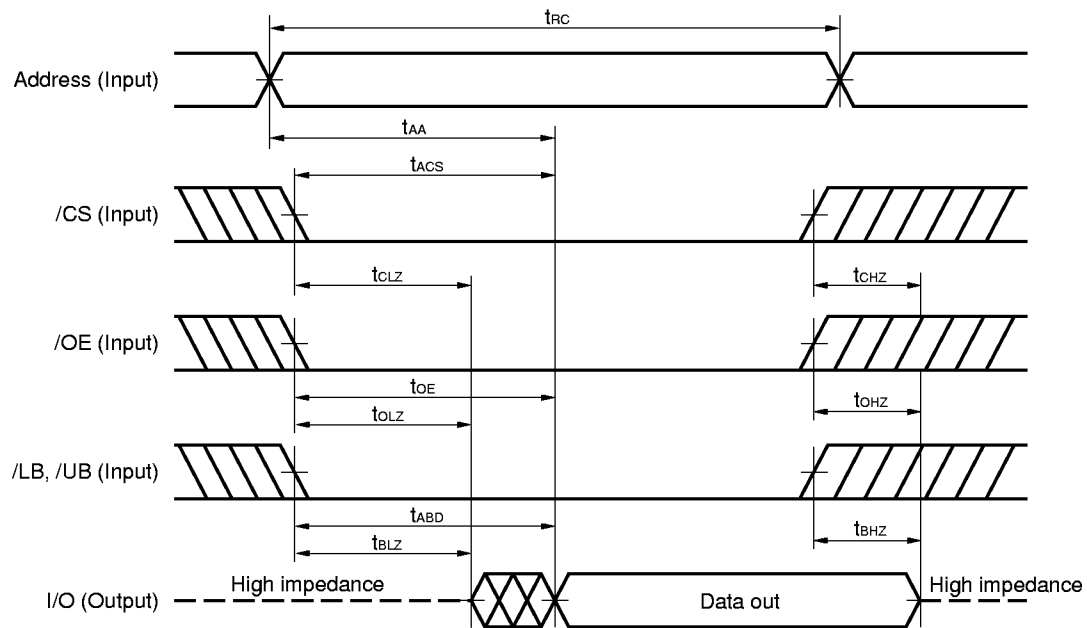
Read Cycle Timing Chart 1 (Address Access)



Remarks 1. In read cycle, /WE should be fixed to high level.

2. /CS = /OE = /LB (or /UB) = V_{IL}

Read Cycle Timing Chart 2 (/CS Access)



Caution Address valid prior to or coincident with /CS low level input.

Remark In read cycle, /WE should be fixed to high level.

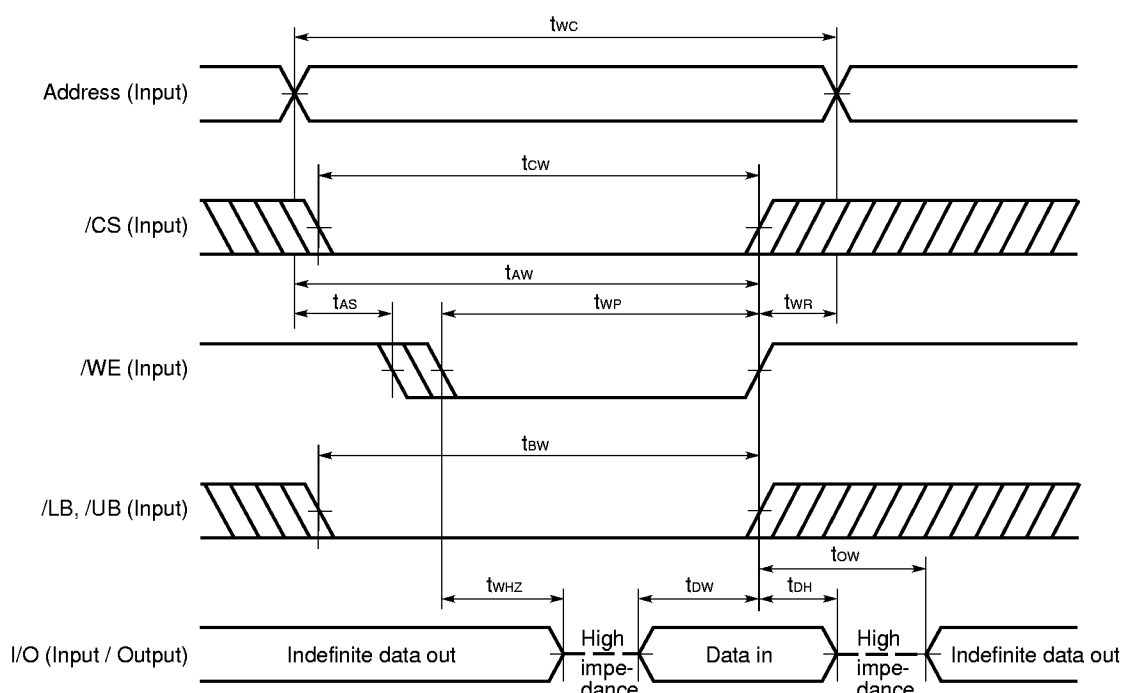
Write Cycle

Parameter	Symbol	-12		-15		-17		-20		Unit	Notes
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
Write cycle time	t_{WC}	12		15		17		20		ns	
/CS to end of write	t_{CW}	8		10		11		12		ns	
Address valid to end of write	t_{AW}	8		10		11		12		ns	
Write pulse width	t_{WP}	8		10		11		12		ns	
/LB, /UB to end of write	t_{BW}	8		10		11		12		ns	
Data valid to end of write	t_{DW}	6		7		8		9		ns	
Data hold time	t_{DH}	0		0		0		0		ns	
Address setup time	t_{AS}	0		0		0		0		ns	
★ Write recovery time	t_{WR}	1		1		1		1		ns	
/WE to output in high impedance	t_{WHZ}		6		7		8		8	ns	1, 2
Output active from end of write	t_{OW}	3		3		3		3		ns	

Notes 1. Transition is measured at ± 200 mV from steady-state voltage with the output load shown in **Figure 2**.

2. These parameters are periodically sampled and not 100% tested.

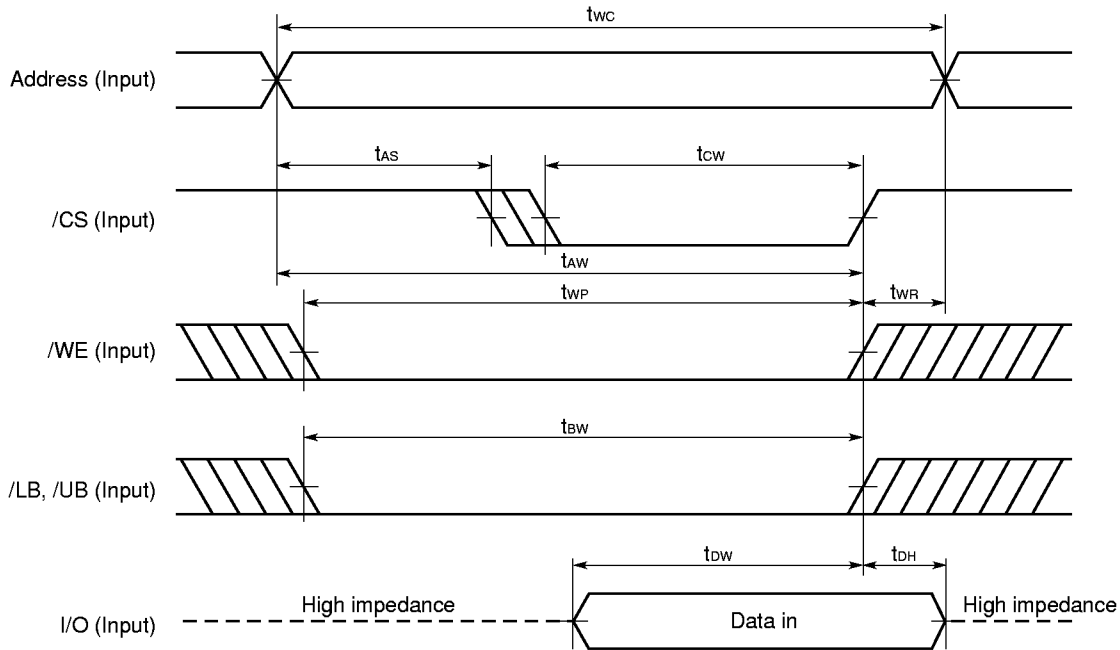
Write Cycle Timing Chart 1 (/WE Controlled)



Caution /CS or /WE should be fixed to high level during address transition.

- Remarks**
1. Write operation is done during the overlap time of a low level /CS, a low level /WE and a low level /LB (or low level /UB).
 2. During t_{WHZ} , I/O pins are in the output state, therefore the input signals of opposite phase to the output must not be applied.
 3. When /WE is at low level, the I/O pins are always high impedance. When /WE is at high level, read operation is executed. Therefore /OE should be at high level to make the I/O pins high impedance.

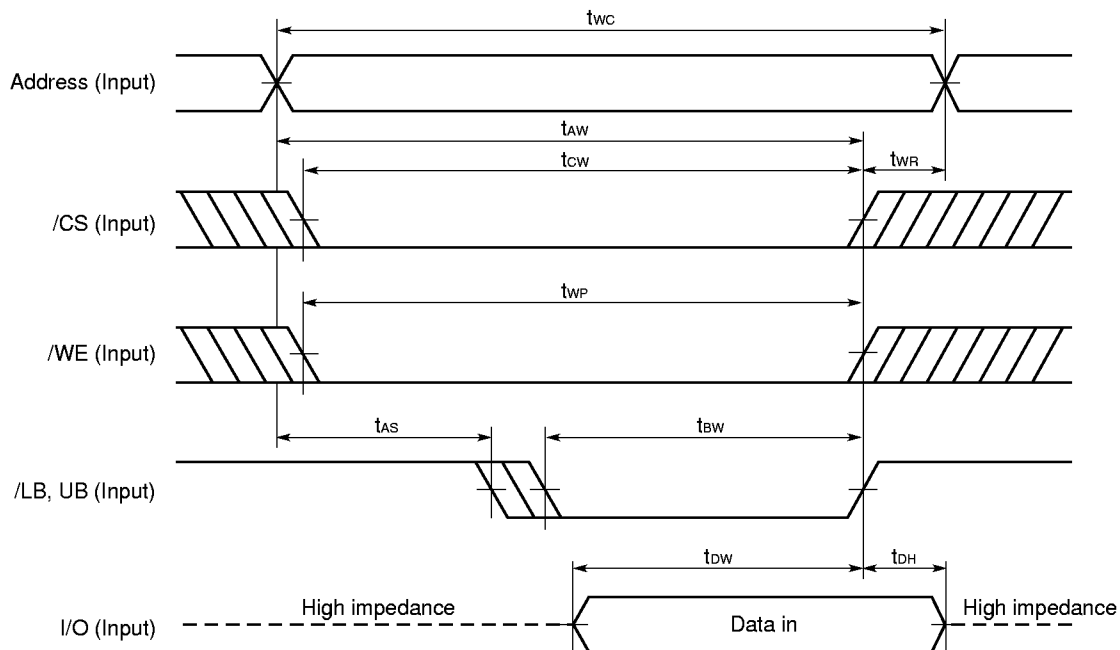
Write Cycle Timing Chart 2 (/CS Controlled)



Caution /CS or /WE should be fixed to high level during address transition.

Remark Write operation is done during the overlap time of a low level /CS, a low level /WE and a low level /LB (or low level /UB).

Write Cycle Timing Chart 3 (/LB, /UB Controlled)

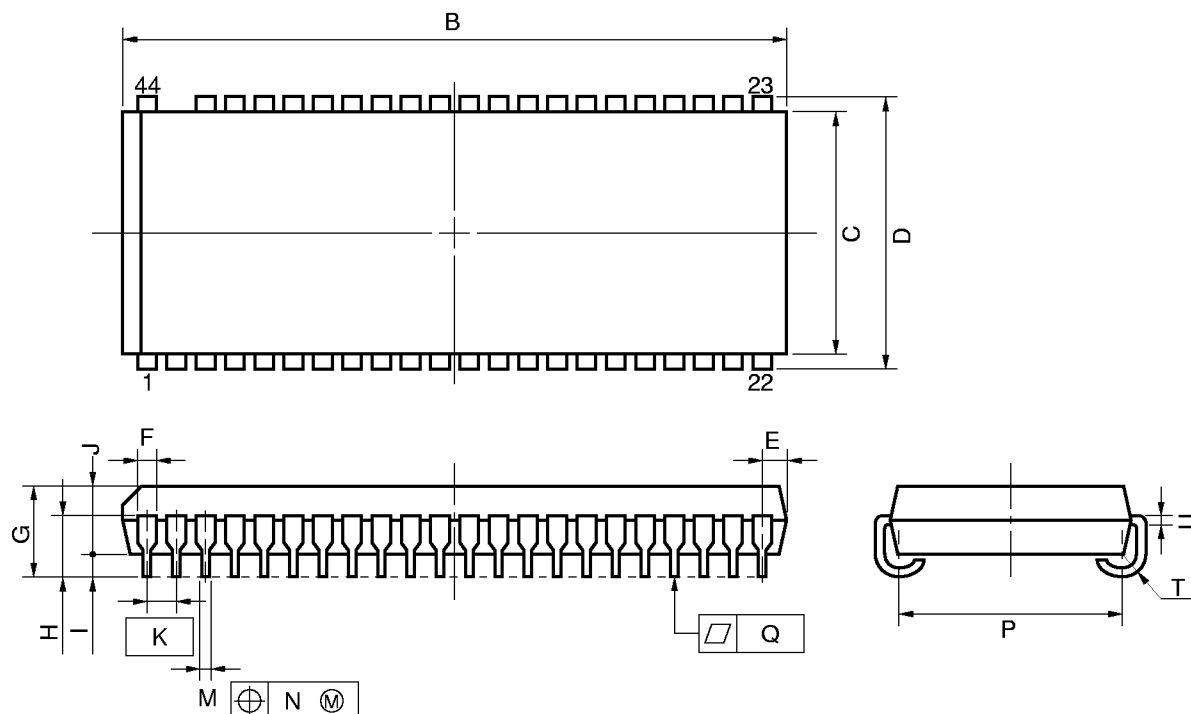


Caution /CS or /WE should be fixed to high level during address transition.

Remark Write operation is done during the overlap time of a low level /CS, a low level /WE and a low level /LB (or low level /UB).

Package Drawings

44 PIN PLASTIC SOJ (400 mil)



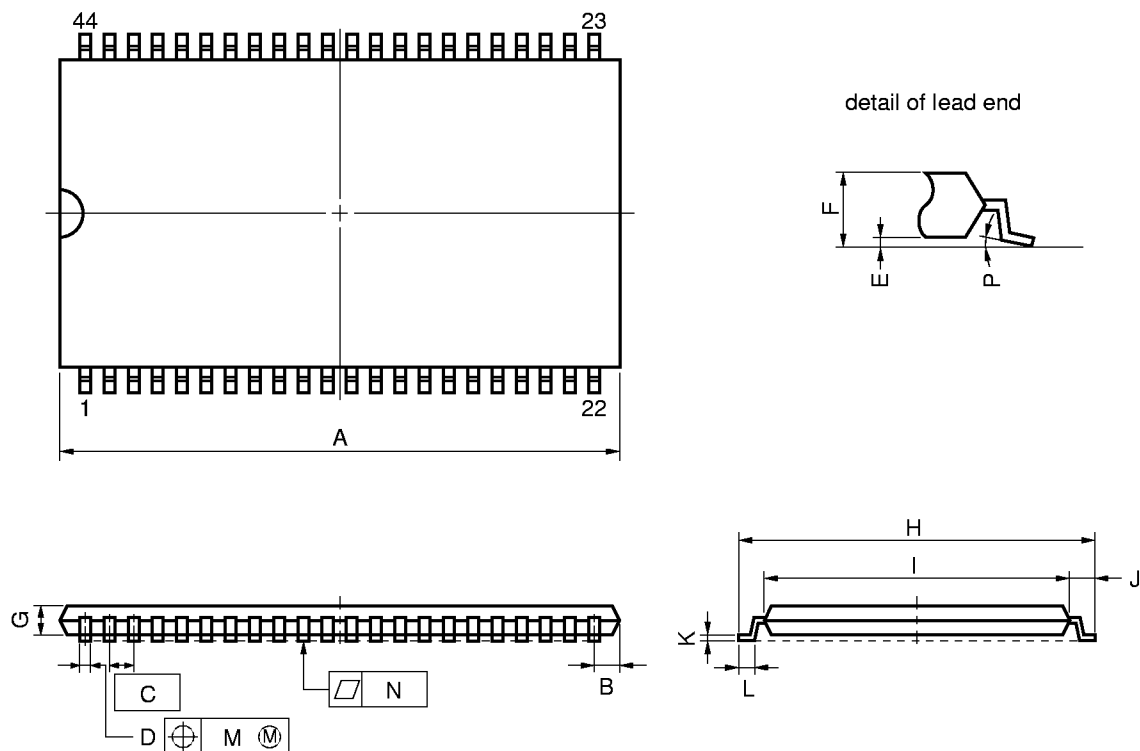
NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

P44LE-400A

ITEM	MILLIMETERS	INCHES
B	28.73 ^{+0.2} _{-0.35}	1.131 ^{+0.008} _{-0.014}
C	10.16	0.400
D	11.18±0.20	0.440±0.008
E	1.03±0.15	0.041 ^{+0.006} _{-0.007}
F	0.74	0.029
G	3.5±0.2	0.138±0.008
H	2.3±0.2	0.091 ^{+0.008} _{-0.009}
I	0.8 MIN.	0.031 MIN.
J	2.6	0.102
K	1.27 (T.P.)	0.050 (T.P.)
M	0.40±0.10	0.016 ^{+0.004} _{-0.005}
N	0.12	0.005
P	9.4±0.20	0.370±0.008
Q	0.10	0.004
T	R 0.85	R 0.033
U	0.20 ^{+0.10} _{-0.05}	0.008 ^{+0.004} _{-0.002}

44 PIN PLASTIC TSOP(II) (400 mil)



NOTE

Each lead centerline is located within 0.13 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES
A	18.63 MAX.	0.734 MAX.
B	0.93 MAX.	0.037 MAX.
C	0.8 (T.P.)	0.031 (T.P.)
D	0.32 ^{+0.08} _{-0.07}	0.013±0.003
E	0.1±0.05	0.004±0.002
F	1.2 MAX.	0.048 MAX.
G	0.97	0.038
H	11.76±0.2	0.463±0.008
I	10.16±0.1	0.400±0.004
J	0.8±0.2	0.031 ^{+0.009} _{-0.008}
K	0.145 ^{+0.025} _{-0.015}	0.006±0.001
L	0.5±0.1	0.020 ^{+0.004} _{-0.005}
M	0.13	0.005
N	0.10	0.004
P	3° ^{+7°} _{-3°}	3° ^{+7°} _{-3°}

S44G5-80-7JF5

Recommended Soldering Conditions

Please consult with our sales offices for soldering conditions of the μ PD434016A.

Type of Surface Mount Device

μ PD434016ALE : 44-pin plastic SOJ (400 mil)

μ PD434016AG5-7JF : 44-pin plastic TSOP (II) (400 mil) (Normal Bent)



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.